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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

January 2016

FJBE2150D
ESBC™ Rated NPN Silicon Transistor

ESBC Features (FDC655 MOSFET)

$V_{CS(ON)}$	I_C	Equiv. $R_{CS(ON)}$
0.131 V	0.5 A	0.261 Ω(1)

- Low Equivalent On Resistance
- Very Fast Switch: 150 kHz
- Squared RBSOA: Up to 1500 V
- Avalanche Rated
- Low Driving Capacitance, No Miller Capacitance (Typ. 12 pF Capacitance at 200 V)
- Low Switching Losses
- Reliable HV Switch: No False Triggering due to High dv/dt Transients

Applications

- High-Voltage and High-Speed Power Switches
- Emitter-Switched Bipolar/MOSFET Cascode (ESBC™)
- Smart Meters, Smart Breakers, HV Industrial Power Supplies
- Motor Drivers and Ignition Drivers

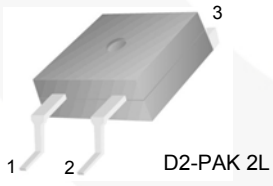
Description

The FJBE2150D is a low-cost, high-performance power switch designed to be used in an ESBC™ configuration in applications such as: power supplies, motor drivers, smart grid, or ignition switches. The power switch is designed to operate up to 1500 volts and up to 3 amps, while providing exceptionally low on-resistance and very low switching losses.

The ESBC™ switch is designed to be driven using off-the-shelf power supply controllers or drivers. The ESBC™ MOSFET is a low-voltage, low-cost, surface-mount device that combines low-input capacitance and fast switching. The ESBC™ configuration further minimizes the required driving power because it does not have Miller capacitance.

The FJBE2150D provides exceptional reliability and a large operating range due to its square Reverse-Bias-Safe-Operating-Area (RBSOA) and rugged design. The device is avalanche rated and has no parasitic transistors, so is not prone to static dv/dt failures.

The power switch is manufactured using a dedicated high-voltage bipolar process and is packaged in high-voltage HV-D2PAK rated at 2500 V creepage and clearance.



1.Base 2.Emitter 3.Collector

Figure 1. Pin Configuration

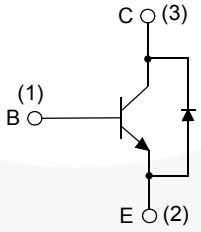


Figure 2. Internal Schematic Diagram

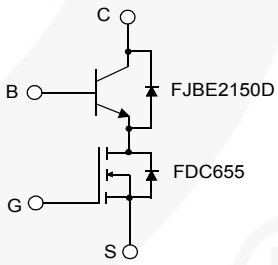


Figure 3. ESBC Configuration(2)

Ordering Information

Part Number	Marking	Package	Packing Method
FJBE2150DTU	J2150D	D2-PAK 2L (TO-263 2L)	Tube

Notes:

1. Figure of Merit.
2. Other Fairchild MOSFETs can be used in this ESBC application.

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Value	Unit
V_{CBO}	Collector-Base Voltage	1500	V
V_{CEO}	Collector-Emitter Voltage	800	V
V_{EBO}	Emitter-Base Voltage	12	V
I_C	Collector Current	2	A
I_{CP}	Collector Current (Pulse)	3	A
I_B	Base Current	1	A
I_{BP}	Base Current (Pulse)	2	A
P_D	Power Dissipation (T_C = 25°C)	110	W
T_J	Operating and Junction Temperature Range	- 55 to +125	°C
T_{STG}	Storage Temperature Range	- 65 to +150	°C
EAS	Avalanche Energy (T_J = 25°C, 8 mH)	3.5	mJ

Thermal Characteristics[3]

Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Max.	Unit
$R_{\theta jc}$	Thermal Resistance, Junction to Case	1.13	°C/W
$R_{\theta ja}$	Thermal Resistance, Junction to Ambient	76.42	°C/W

Note:

3. Device mounted on FR-4 PCB, board size = 76.2 mm x 114.3 mm, land pattern 12.70 mm x 9.45 mm, trace size = 10 mil.

Electrical Characteristics[4]

Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{CBO}	Collector-Base Breakdown Voltage	I_C = 0.5 mA, I_E = 0	1500	1689		V
BV_{CEO}	Collector-Emitter Breakdown Voltage	I_C = 5 mA, I_B = 0	800	870		V
BV_{EBO}	Emitter-Base Breakdown Voltage	I_E = 0.5 mA, I_C = 0	12.0	14.8		V
I_{CES}	Collector Cut-off Current	V_{CE} = 1500 V, V_{BE} = 0		0.01	100	μA
I_{CEO}	Collector Cut-off Current	V_{CE} = 800 V, I_B = 0		0.01	100	μA
I_{EBO}	Emitter Cut-off Current	V_{EB} = 12 V, I_C = 0		0.05	500	μA
h_{FE}	DC Current Gain	V_{CE} = 3 V, I_C = 0.4 A	20	29	35	
		V_{CE} = 10 V, I_C = 5 mA	20	43		
V_{CE}(sat)	Collector-Emitter Saturation Voltage	I_C = 0.25 A, I_B = 0.05 A		0.16		V
		I_C = 0.5 A, I_B = 0.167 A		0.12		
		I_C = 1 A, I_B = 0.33 A		0.25		
V_{BE}(sat)	Base-Emitter Saturation Voltage	I_C = 500 mA, I_B = 50 mA		0.74	1.20	V
		I_C = 2 A, I_B = 0.4 A		0.85	1.20	
C_{IB}	Input Capacitance	V_{EB} = 10 V, I_C = 0, f = 1 MHz		745	1000	pF
C_{OB}	Output Capacitance	V_{CB} = 200 V, I_E = 0, f = 1 MHz		15		pF
f_T	Current Gain Bandwidth Product	I_C = 0.1 A, V_{CE} = 10 V		5		MHz
V_F	Diode Forward Voltage	I_F = 0.4 A		0.76	1.20	V
		I_F = 1 A		0.83	1.50	

Note:

4. Pulse test: pulse width = 20 μs, duty cycle≤ 10%.

ESBC Configured Electrical Characteristics(5)

Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
f_T	Current Gain Bandwidth Product	I_C = 0.1 A,V_{CE} = 10 V		25		MHz
It_f	Inductive Current Fall Time	V_{GS} = 10 V, R_G = 47 Ω, V_{Clamp} = 500 V, t_p = 3.1 µs, I_C = 0.3 A, I_B = 0.03 A, L_C = 1 mH, SRF = 480 kHz		137		ns
t_s	Inductive Storage Time			350		ns
Vt_f	Inductive Voltage Fall Time			120		ns
Vt_r	Inductive Voltage Rise Time			100		ns
t_c	Inductive Crossover Time			137		ns
It_f	Inductive Current Fall Time	V_{GS} = 10 V, R_G = 47 Ω, V_{Clamp} = 500 V, t_p = 10 µs, I_C = 1 A, I_B = 0.2 A, L_C = 1 mH, SRF = 480 kHz		35		ns
t_s	Inductive Storage Time			980		ns
Vt_f	Inductive Voltage Fall Time			30		ns
Vt_r	Inductive Voltage Rise Time			195		ns
t_c	Inductive Crossover Time			210		ns
V_{CSW}	Maximum Collector Source Voltage at Turn-off without Snubber	h_{FE} = 5, I_C = 2 A	1500			V
$I_{GS(OS)}$	Gate-Source Leakage Current	V_{GS} = ±20 V		1.0		nA
$V_{CS(ON)}$	Collector-Source On Voltage	V_{GS} = 10 V, I_C = 2 A, I_B = 0.67 A, h_{FE} = 3		2.210		V
		V_{GS} = 10 V, I_C = 1 A, I_B = 0.33 A, h_{FE} = 3		0.321		
		V_{GS} = 10 V, I_C = 0.5 A, I_B = 0.17 A, h_{FE} = 3		0.131		
		V_{GS} = 10 V, I_C = 0.3 A, I_B = 0.06 A, h_{FE} = 5		0.166		
$V_{GS(th)}$	Gate Threshold Voltage	V_{BS} = V_{GS}, I_B = 250 µA		1.9		V
C_{iss}	Input Capacitance (V_{GS} = V_{CB} = 0)	V_{CS} = 25 V, f = 1 MHz		470		pF
$Q_{GS(tot)}$	Gate-Source Charge V_{CB} = 0	V_{GS} = 10 V, I_C = 8 A, V_{CS} = 25 V		9		nC
$r_{DS(ON)}$	Static Drain-Source On Resistance	V_{GS} = 10 V, I_D = 6.3 A		21		mΩ
		V_{GS} = 4.5 V, I_D = 5.5 A		26		
		V_{GS} = 10 V, I_D = 6.3 A, T_J = 125°C		30		

Note:

5. Used typical FDC655 MOSFET values in table. Values can vary if other Fairchild MOSFETs are used.

Typical Performance Characteristics

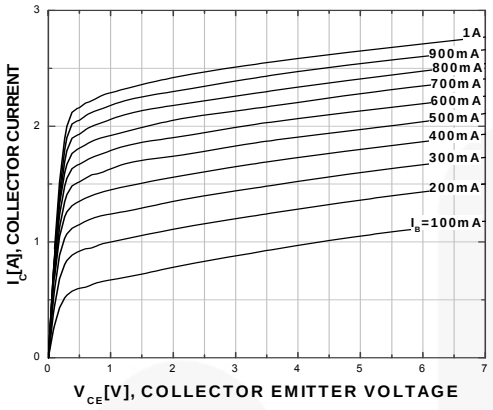


Figure 4. Static Characteristic

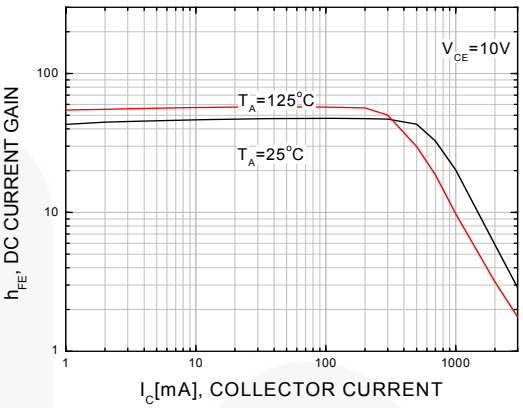


Figure 5. DC Current Gain

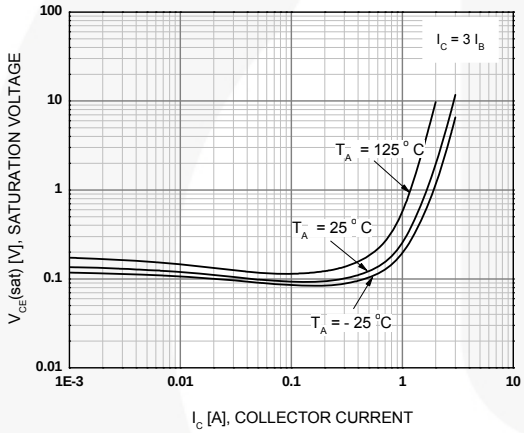


Figure 6. Collector-Emitter Saturation Voltage
h_{FE} = 3

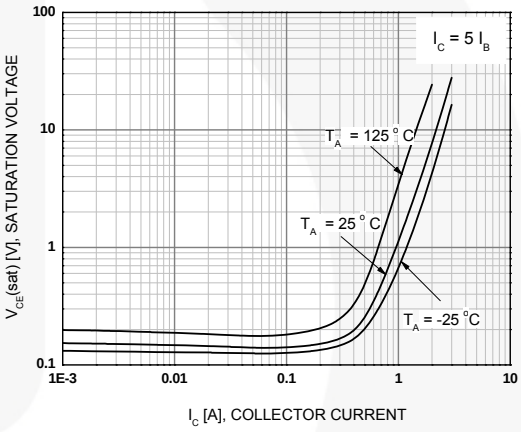


Figure 7. Collector-Emitter Saturation Voltage
h_{FE} = 5

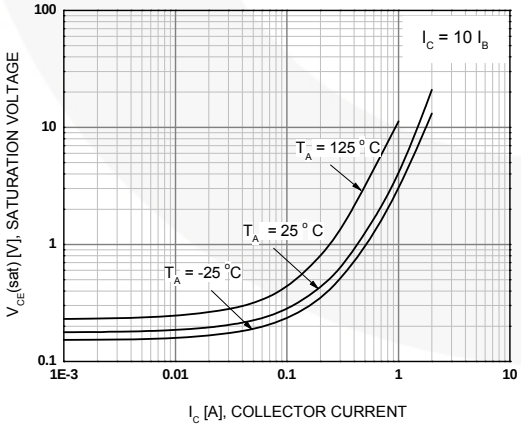


Figure 8. Collector-Emitter Saturation Voltage
h_{FE} = 10

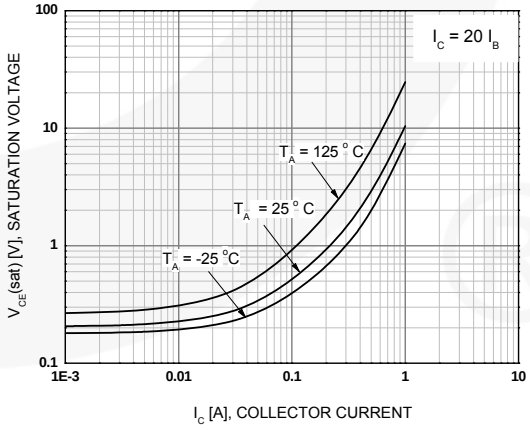


Figure 9. Collector-Emitter Saturation Voltage
h_{FE} = 20

Typical Performance Characteristics (Continued)

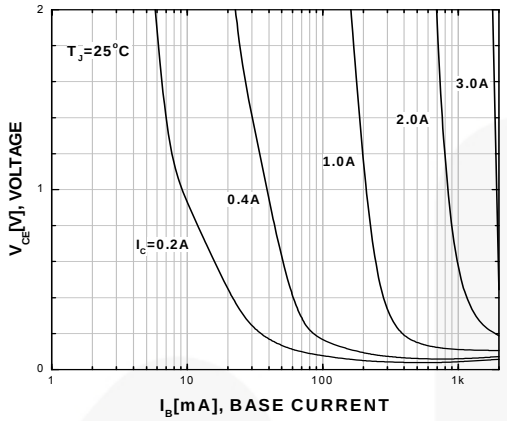


Figure 10. Typical Collector Saturation Voltage

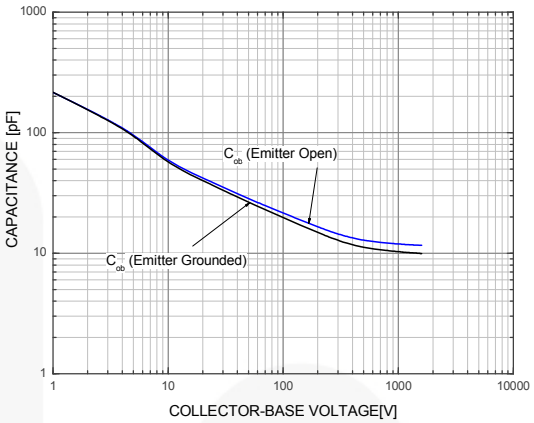


Figure 11. Capacitance

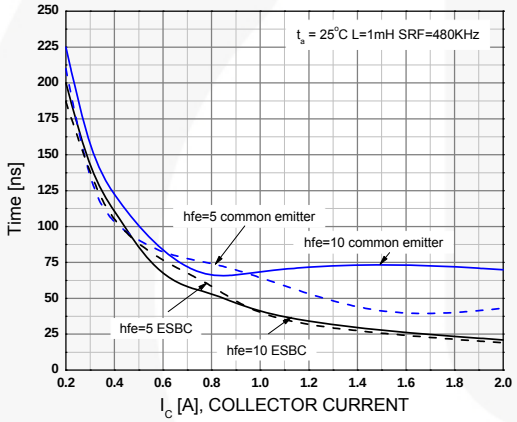


Figure 12. Inductive Load Collector Current Fall-Time (t_f)

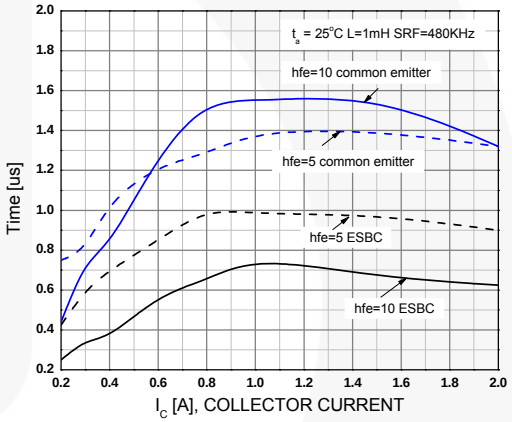


Figure 13. Inductive Load Collector Current Storage Time (t_{stg})

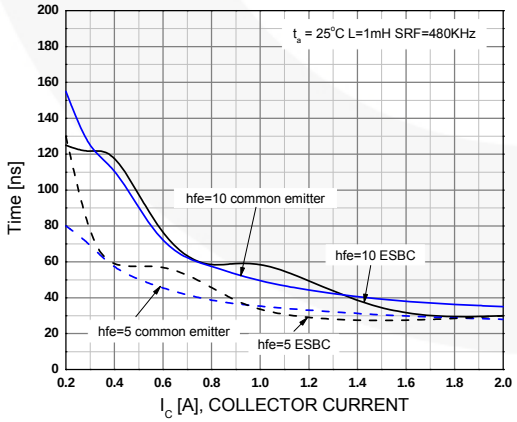


Figure 14. Inductive Load Collector Voltage Fall-Time (t_f)

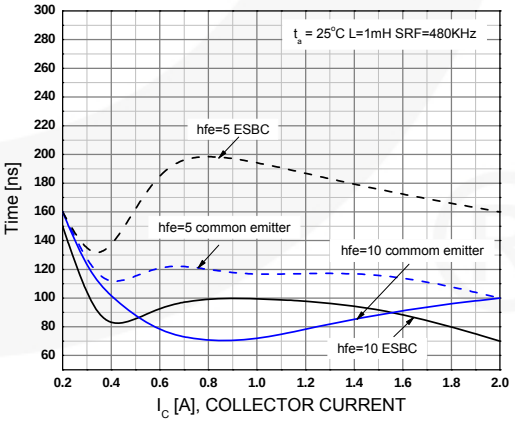


Figure 15. Inductive Load Collector Voltage Rise-Time (t_r)

Typical Performance Characteristics (Continued)

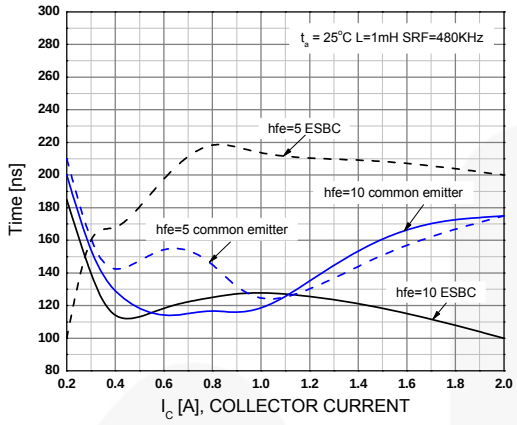


Figure 16. Inductive Load Collector Current / Voltage Crossover (t_c)

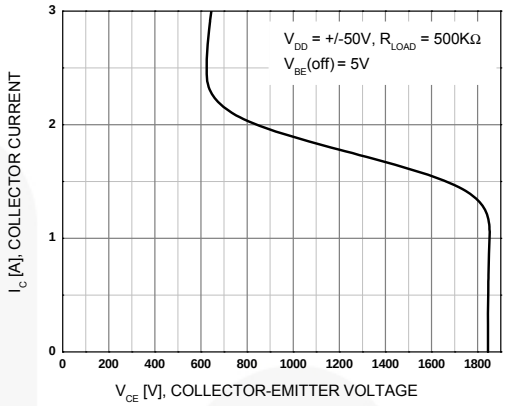


Figure 17. BJT Reverse Bias Safe Operating Area

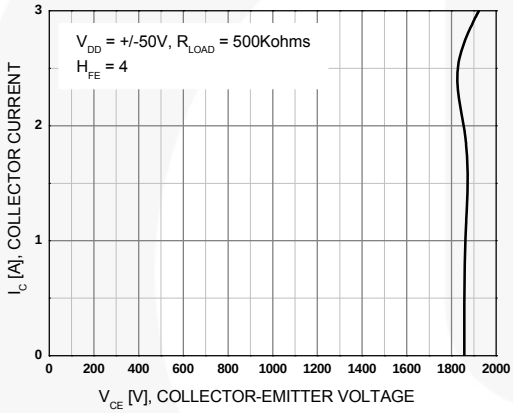


Figure 18. ESBC RBSOA

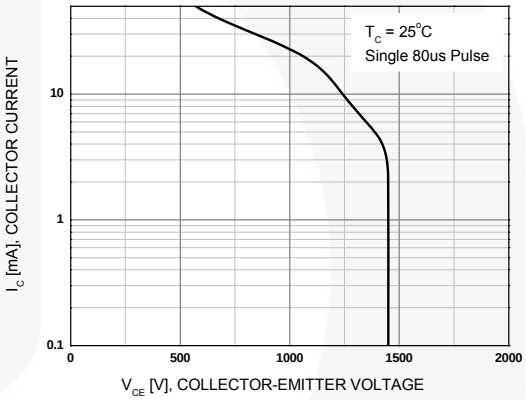


Figure 19. Crossover Forward Bias Safe Operating Area (FBSOA)

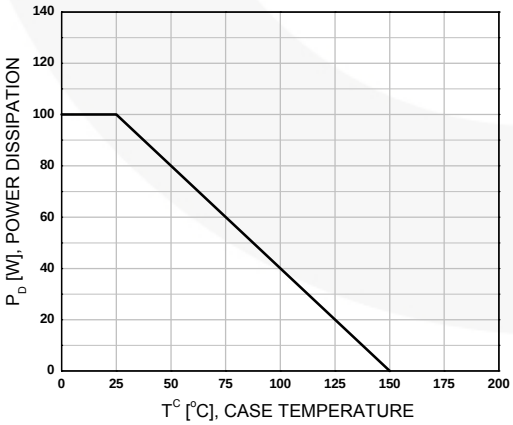


Figure 20. Power Derating

Test Circuits

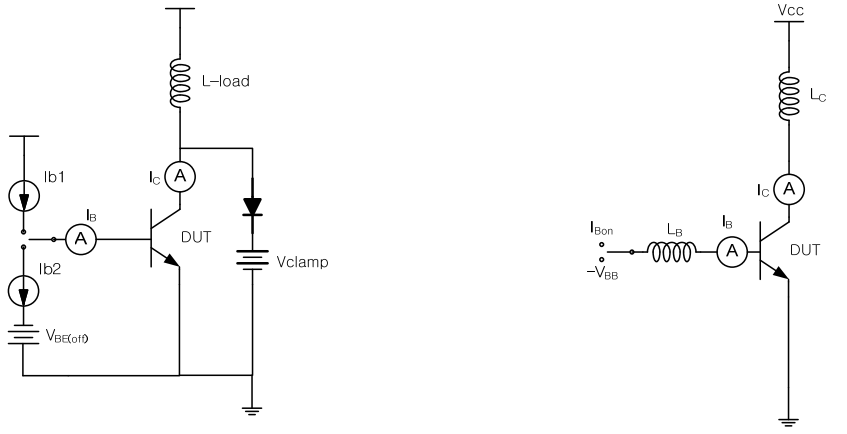


Figure 21. Test Circuit for Inductive Load and Reverse Bias Safe Operating

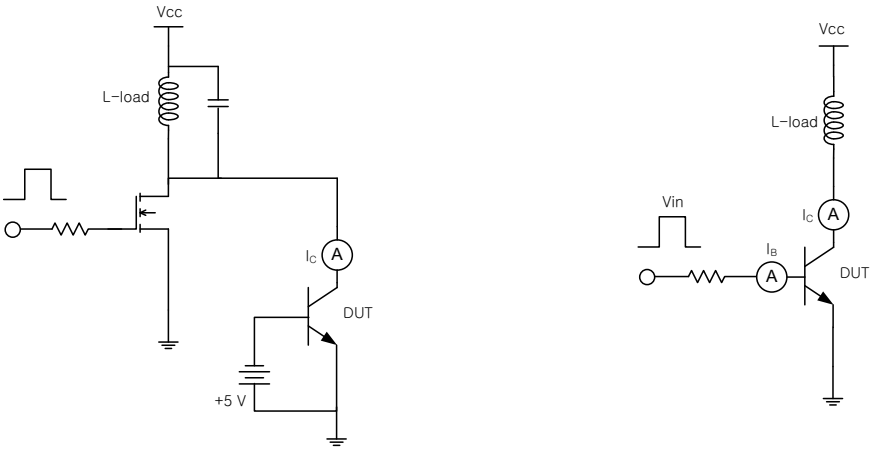


Figure 22. Energy Rating Test Circuit

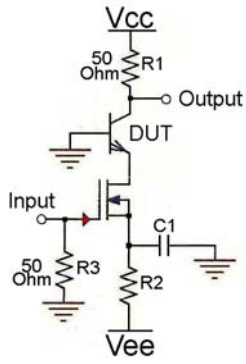


Figure 23. f_T Measurement

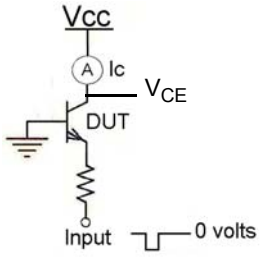


Figure 24. FBSOA

Test Circuits (Continued)

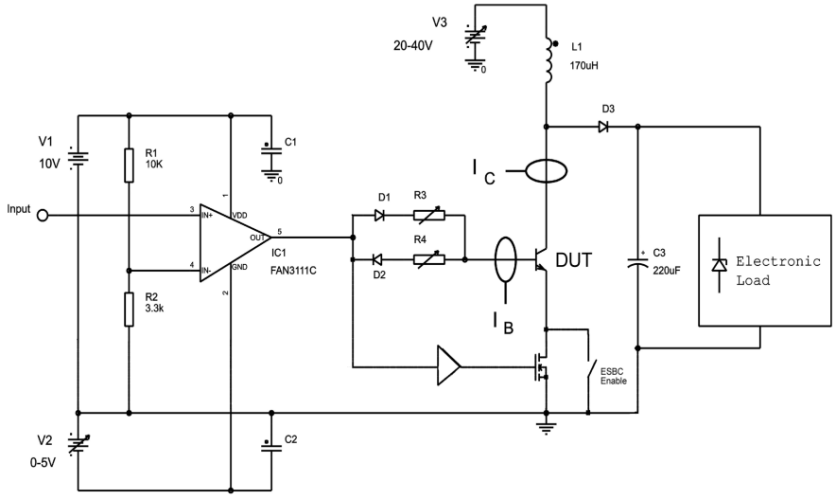


Figure 25. Simplified Saturated Switch Driver Circuit

Functional Test Waveforms

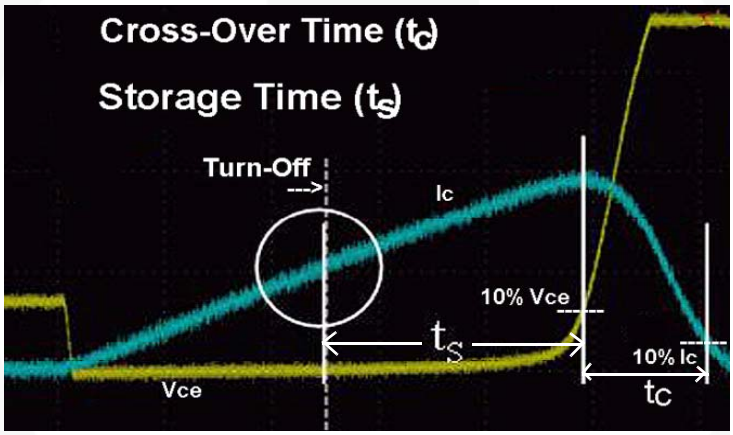


Figure 26. Crossover Time Measurement

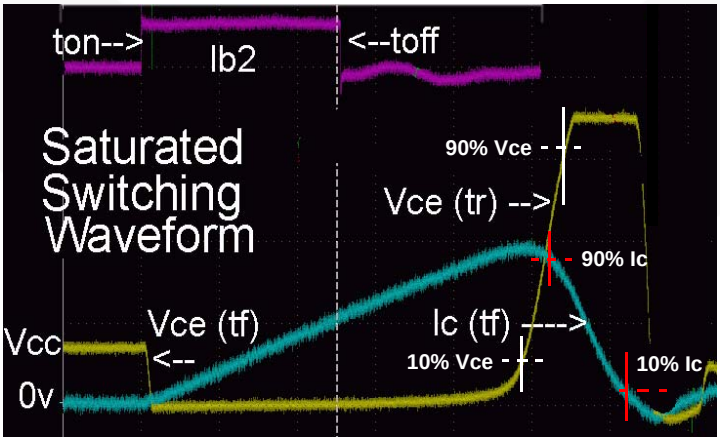


Figure 27. Saturated Switching Waveform

Functional Test Waveforms (Continued)

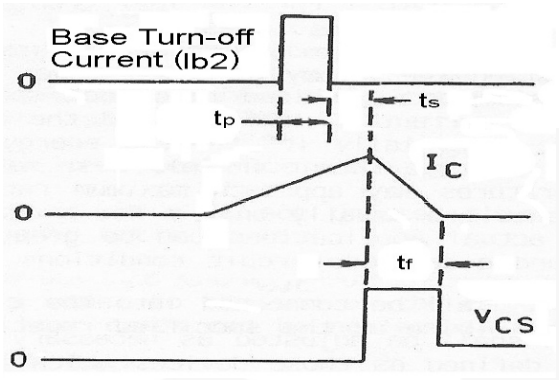


Figure 28. Storage Time - Common Emitter Base Turn-off (Ib2) to I_C Fall-Time

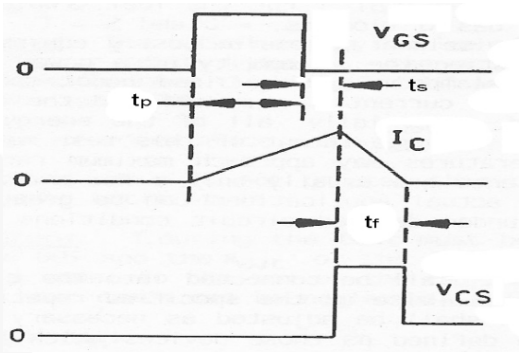


Figure 29. Storage Time - ESBC FET Gate (off) to I_C Fall-Time

Very Wide Input Voltage Range Supply

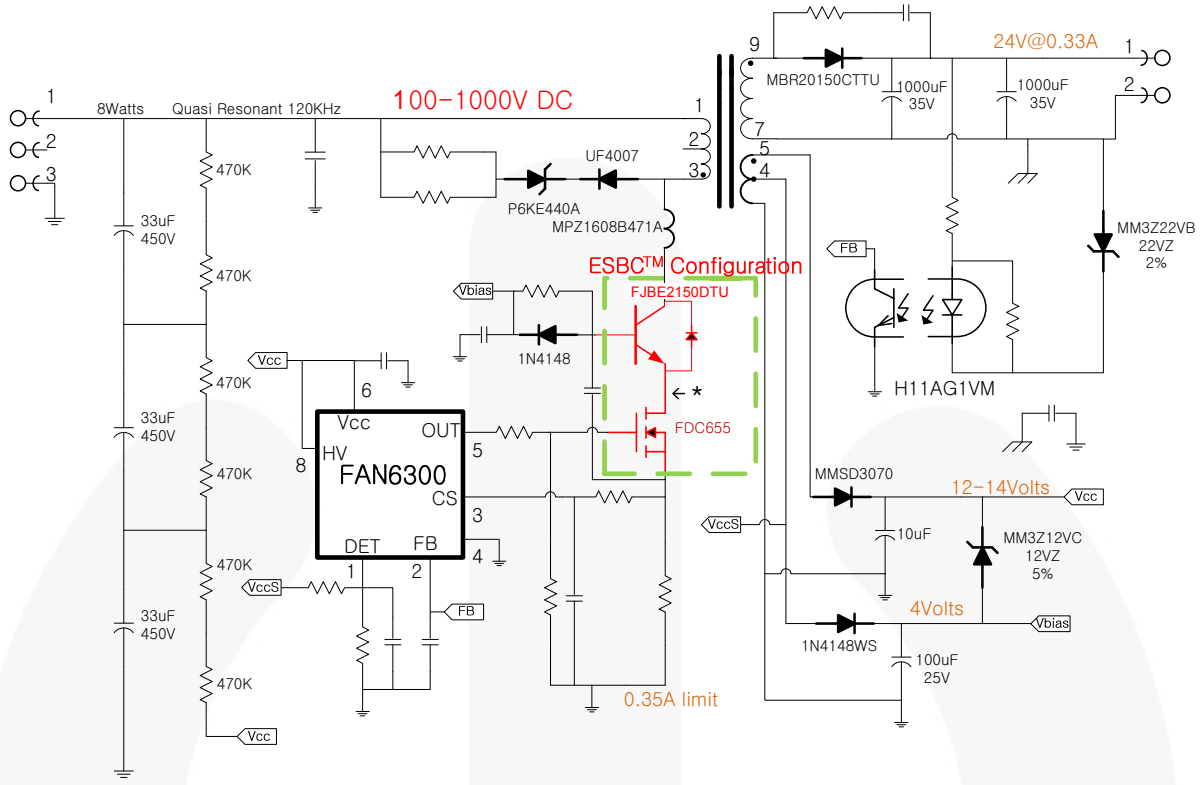


Figure 30. 8 W; Secondary-Side Regulation: 3 Capacitor Input; Quasi Resonant

Driving ESBC Switches

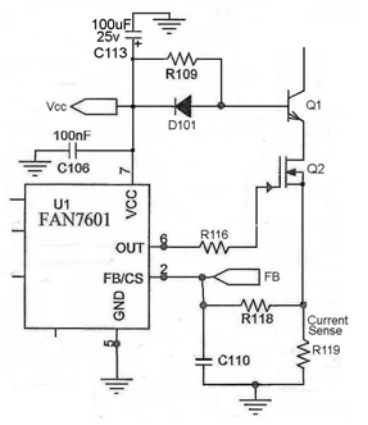


Figure 31. V_{CC} Derived

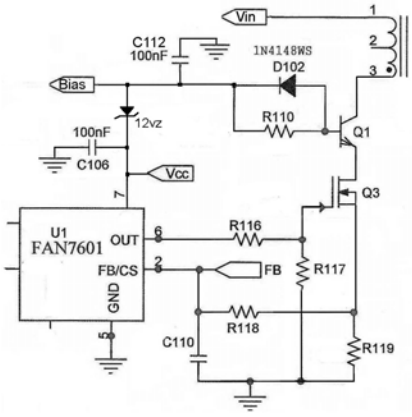


Figure 32. V_{bias} Supply Derived

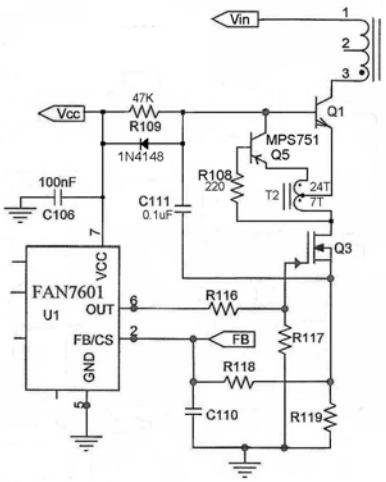


Figure 33. Proportional Drive

Physical Dimensions

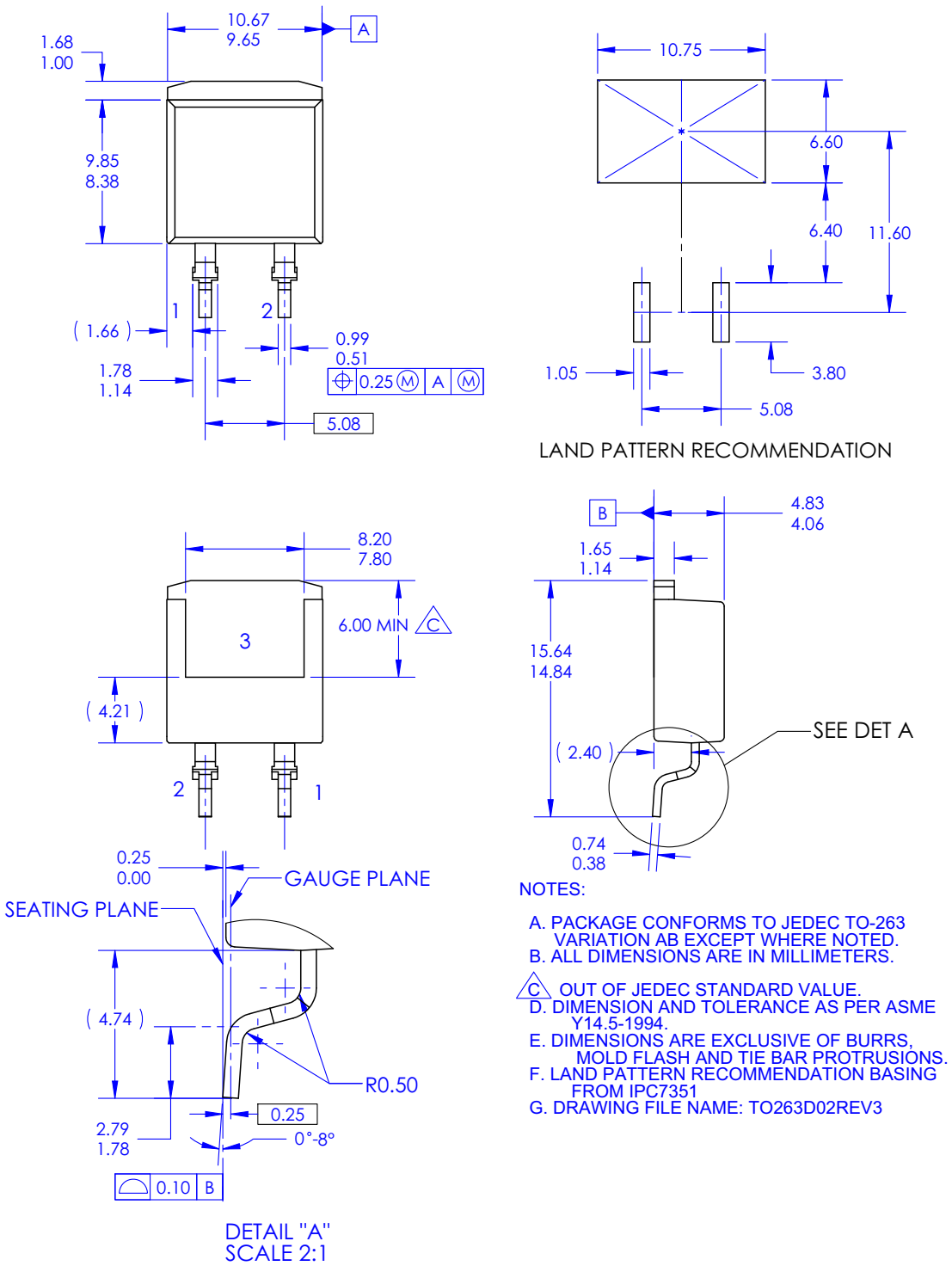


Figure 34. 2 LEAD, TO-263, JEDEC TO263 VARIATION AB, D2PAK

TRADEMARKS

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AttitudeEngine™
Awinda®
AX-CAP®*
BitSiC™
Build it Now™
CorePLUS™
CorePOWER™
CROSSVOLT™
CTL™
Current Transfer Logic™
DEUXPEED®
Dual Cool™
EcoSPARK®
EfficientMax™
ESBC™
F®
Fairchild®
Fairchild Semiconductor®
FACT Quiet Series™
FACT®
FastvCore™
FETBench™
FPS™
F-PFS™
FRFET®
Global Power Resource SM
GreenBridge™
Green FPS™
Green FPS™ e-Series™
G*max*™
GTO™
IntelliMAX™
ISOPLANAR™
Making Small Speakers Sound Louder and Better™
MegaBuck™
MICROCOUPLER™
MicroFET™
MicroPak™
MicroPak2™
MillerDrive™
MotionMax™
MotionGrid®
MTi®
MTx®
MVN®
mWSaver®
OptoHiT™
OPTOLOGIC®
OPTOPLANAR®
®
Power Supply WebDesigner™
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